



#### N-Channel Enhancement Mode Power MOSFET

#### **Description**

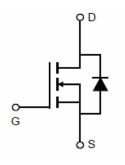
The RM50N60DF uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

- V<sub>DS</sub> =60V,I<sub>D</sub> =50A
  - $R_{DS(ON)} < 16m\Omega$  @ V <sub>GS</sub>=10V
  - $R_{DS(ON)} < 18m\Omega$  @  $V_{GS}$ =4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

### **Application**

- PWM
- Load Switching
- Halogen-free



**Schematic Diagram** 





**Top View** 

**Bottom View** 

#### 100% UIS TESTED! 100% ∆Vds TESTED!

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
50N60	RM50N60DF	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	50	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100°C)	33	А
Pulsed Drain Current	I <sub>DM</sub>	120	А
Maximum Power Dissipation	P <sub>D</sub>	104	W
Derating factor		0.6	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	390	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	°C

### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	Rejc	1.2	°C/W
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# Electrical Characteristics (T<sub>C</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	,					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	10	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Characteristics (Note 3)	1		'			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	-	3.0	V
Dunin Course On State Begintones	В	V <sub>GS</sub> =10V, I <sub>D</sub> =25A	5A -		16	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{DS}$ = $V_{GS}$ , $I_D$ =250 $\mu$ A	-	-	18	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =30A	-	71	-	S
Dynamic Characteristics (Note4)	-					
Input Capacitance	C <sub>lss</sub>	\\ -00\\\\ -0\\	-	1920	2300	pF
Output Capacitance	Coss		-	185	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIHZ	-	80	-	pF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DS} = 30V, I_{D} = 20A,$	-	43	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =3.3 $\Omega$	-	47	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	80	-	nS
Total Gate Charge	Qg	\/ 40\/ L 00 A	-	33	45	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=48V, I_{D}=20A,$	-	5	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =4.5V	-	21	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	-	1.3	V
Diode Forward Current (Note 2)	Is		-	-	80	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, Is = 10A	-	30	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	18	-	nC

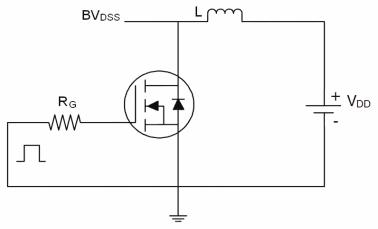
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- **5.**  $E_{AS}$  condition :  $Tj=25^{\circ}C$ ,  $V_{DD}=30V$ ,  $V_{G}=10V$ , L=0.5mH,  $Rg=25\Omega$

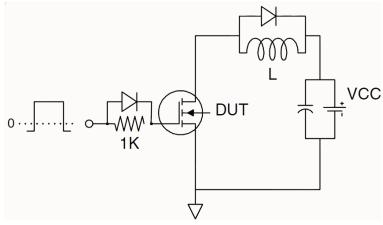


# **Test circuit**

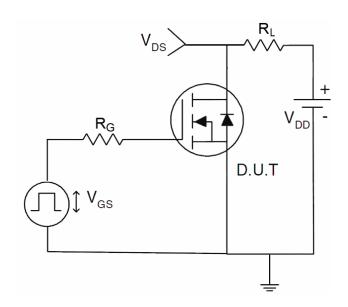
# 1) E<sub>AS</sub> Test Circuit



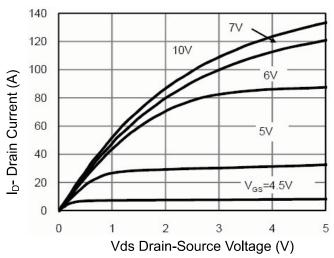
## 2) Gate Charge Test Circuit



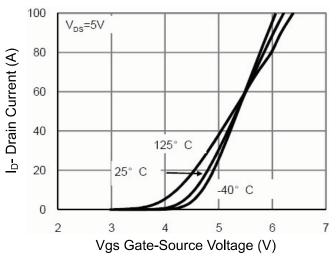
# 3) Switch Time Test Circuit



### RATING AND CHARACTERISTICS CURVES (RM50N60DF)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

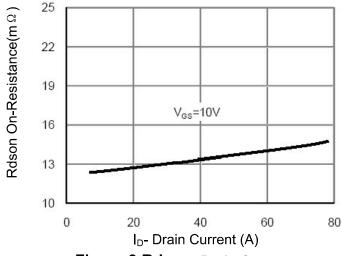


Figure 3 Rdson- Drain Current

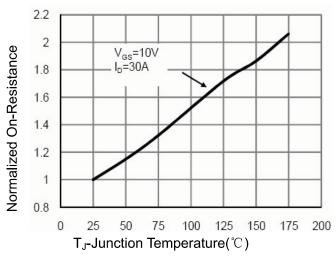
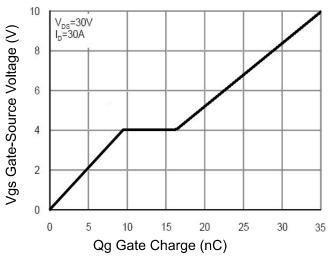


Figure 4 Rdson-JunctionTemperature



**Figure 5 Gate Charge** 

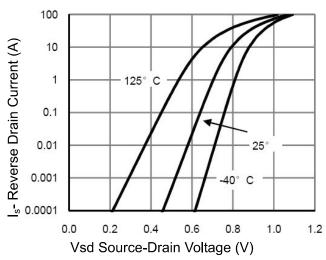


Figure 6 Source- Drain Diode Forward

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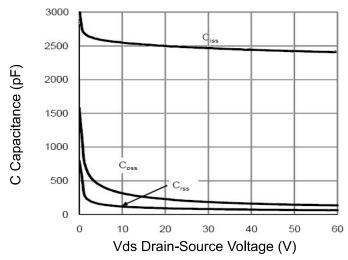


Figure 7 Capacitance vs Vds

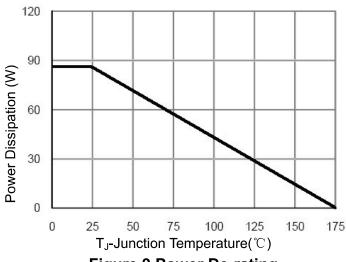
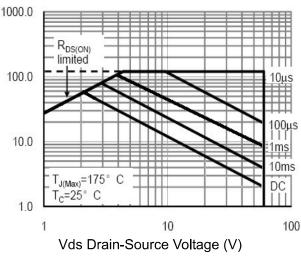


Figure 9 Power De-rating



**Figure 8 Safe Operation Area** 

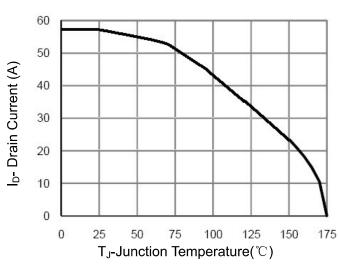
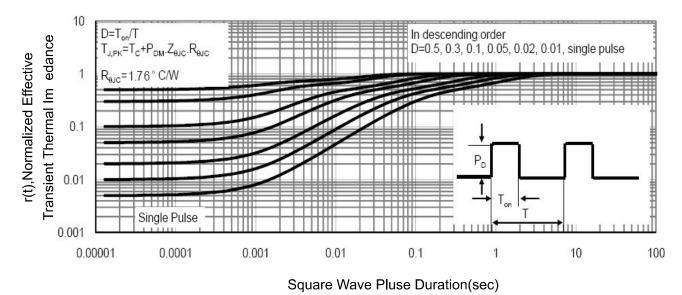


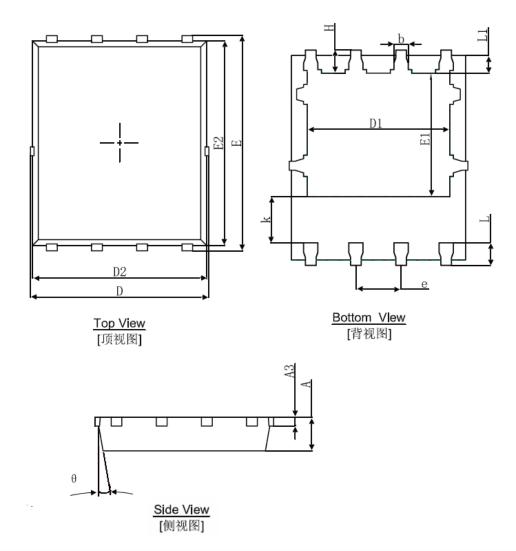
Figure 10 ID Current- JunctionTemperature



**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **DFN5X6-8L Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min.	Max.	Min.	Max.		
Α	0.900	1.000	0.035	0.039		
A3	0.254	REF.	0.010	REF.		
D	4.944	5.096	0.195	0.201		
E	5.974	6.126	0.235	0.241		
D1	3.910	4.110	0.154	0.162		
E1	3.375	3.575	0.133	0.141		
D2	4.824	4.976	0.190	0.196		
E2	5.674	5.826	0.223	0.229		
k	1.190	1.390	0.047	0.055		
b	0.350	0.450	0.014	0.018		
е	1.270	TYP.	0.050TYP.			
L	0.559	0.711	0.022	0.028		
L1	0.424	0.576	0.017	0.023		
Н	0.574	0.726	0.023	0.029		
θ	8°	12°	8°	12°		

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